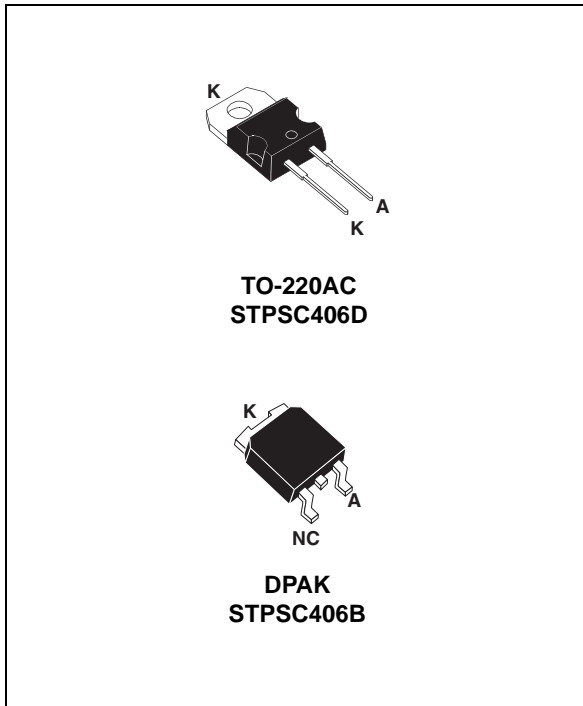


600 V power Schottky silicon carbide diode

Datasheet - production data


Description

The SiC diode is an ultrahigh performance power Schottky diode. It is manufactured using a silicon carbide substrate. The wide bandgap material allows the design of a Schottky diode structure with a 600 V rating. Due to the Schottky construction no recovery is shown at turn-off and ringing patterns are negligible. The minimal capacitive turn-off behavior is independent of temperature.

ST SiC diodes will boost the performance of PFC operations in hard switching conditions.

Table 1. Device summary

$I_{F(AV)}$	4 A
V_{RRM}	600 V
$T_j (max)$	175 °C
$Q_C (typ)$	3 nC

Features

- No or negligible reverse recovery
- Switching behavior independent of temperature
- Dedicated to PFC boost diode

1 Characteristics

Table 2. Absolute ratings (limiting values at 25 °C unless otherwise specified)

Symbol	Parameter		Value	Unit
V _{RRM}	Repetitive peak reverse voltage		600	V
I _{F(RMS)}	Forward rms current		11	A
I _{F(AV)}	Average forward current	DPAK, T _c = 110 °C, δ = 0.5	4	A
		TO-220AC, T _c = 95 °C, δ = 0.5		
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms sinusoidal, T _c = 25 °C	14	A
		t _p = 10 ms sinusoidal, T _c = 125 °C	10	
		t _p = 10 μs square, T _c = 25 °C	40	
I _{FRM}	Repetitive peak forward current	DPAK, T _c = 115 °C, T _j = 150 °C, δ = 0.1	14	A
		TO-220AC, T _c = 105 °C, T _j = 150 °C, δ = 0.1		
T _{stg}	Storage temperature range		-55 to +175	°C
T _j	Operating junction temperature ⁽¹⁾		-40 to +175	°C

1. $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter		Value	Unit
R _{th(j-c)}	Junction to case	TO-220AC	5.5	°C/W
		DPAK	4.5	

Table 4. Static electrical characteristics

Symbol	Parameter	Tests conditions		Min.	Typ.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	V _R = V _{RRM}	-	10	50	μA
		T _j = 150 °C		-	60	500	
V _F ⁽²⁾	Forward voltage drop	T _j = 25 °C	I _F = 4 A	-	1.55	1.9	V
		T _j = 150 °C		-	1.9	2.4	

1. t_p = 10 ms, δ < 2%

2. t_p = 500 μs, δ < 2%

To evaluate the conduction losses use the following equation:

$$P = 1.20 \times I_{F(AV)} + 0.3 \times I_{F(RMS)}^2$$

Table 5. Other parameters

Symbol	Parameter	Test conditions	Typ.	Unit
Q_C	Total capacitive charge	$V_r = 400\text{ V}$, $I_F = 4\text{ A}$ $di_F/dt = -200\text{ A}/\mu\text{s}$ $T_j = 150\text{ }^\circ\text{C}$	3	nC
C	Total capacitance	$V_r = 0\text{ V}$, $T_C = 25\text{ }^\circ\text{C}$, $F = 1\text{ Mhz}$	200	pF
		$V_r = 400\text{ V}$, $T_C = 25\text{ }^\circ\text{C}$, $F = 1\text{ Mhz}$	20	

Figure 1. Forward voltage drop versus forward current (typical values)

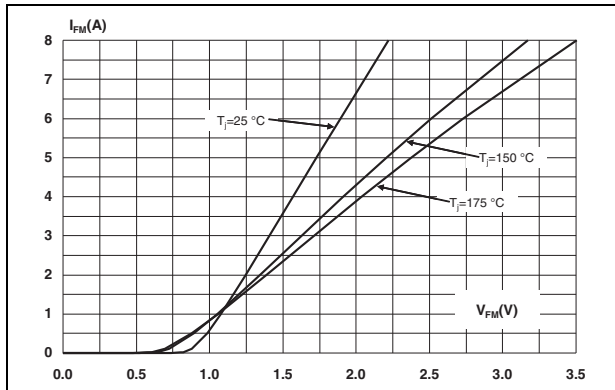


Figure 2. Reverse leakage current versus reverse voltage applied (maximum values)

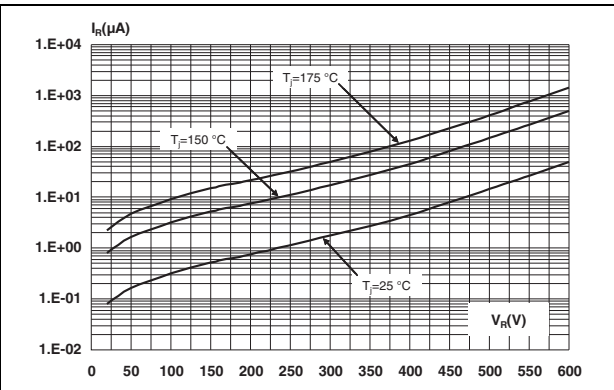


Figure 3. Peak forward current versus case temperature (TO-220AC)

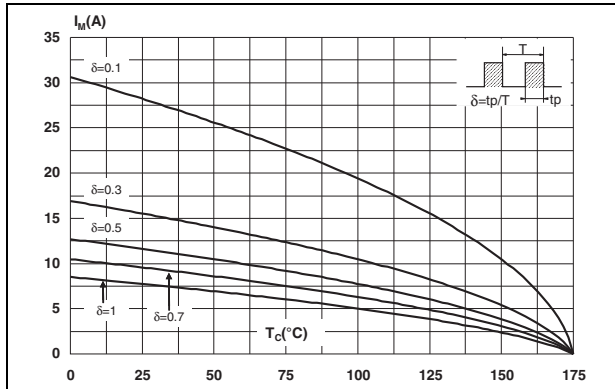


Figure 4. Peak forward current versus case temperature (DPAK)

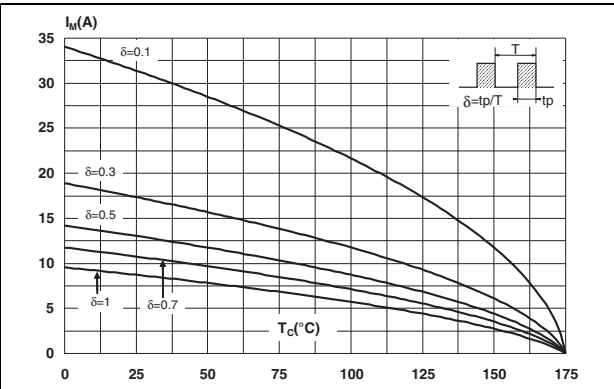


Figure 5. Junction capacitance versus reverse voltage applied (typical values)

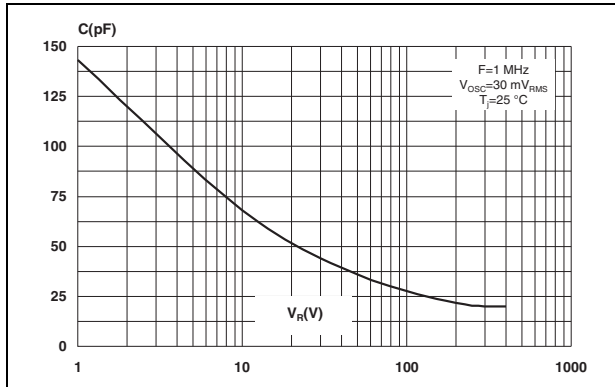


Figure 6. Relative variation of thermal impedance junction to case versus pulse duration (TO-220AC)

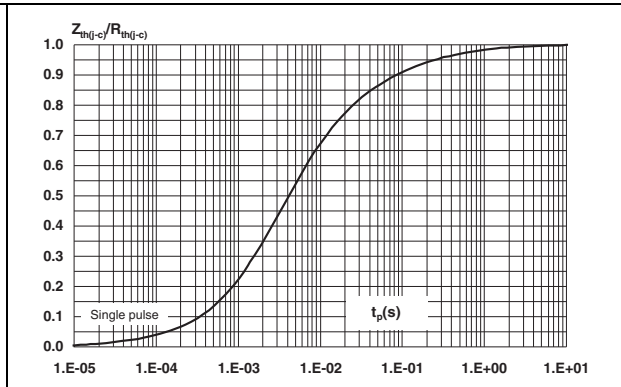


Figure 7. Relative variation of thermal impedance junction to case versus pulse duration (DPAK)

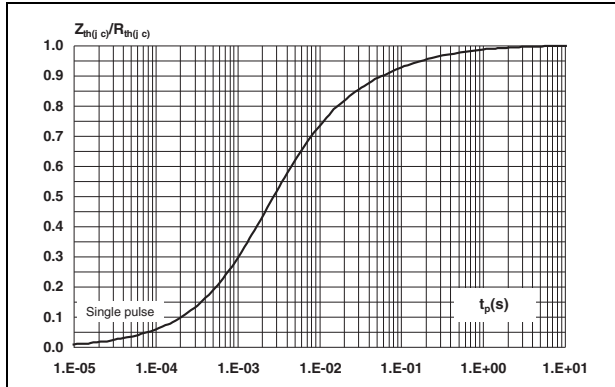


Figure 8. Non-repetitive peak surge forward current versus pulse duration (sinusoidal waveform)

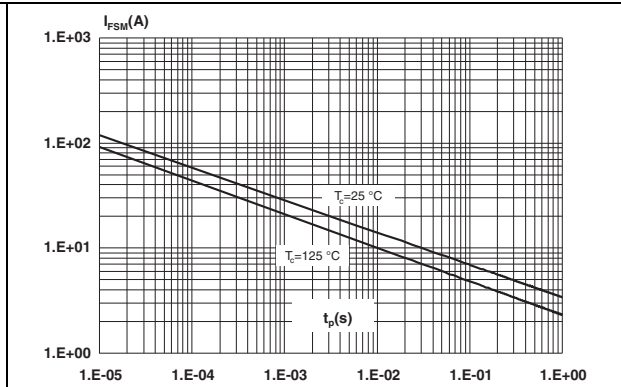
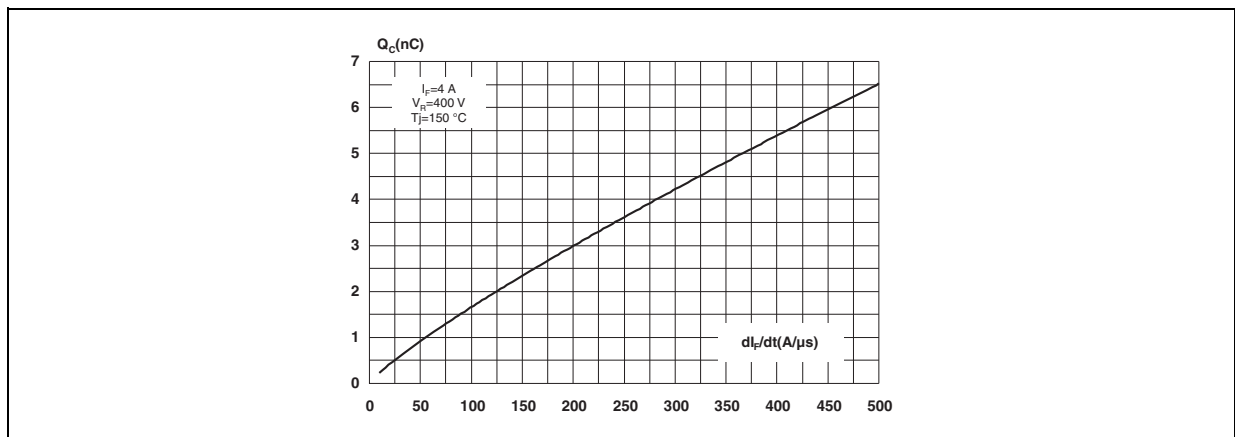


Figure 9. Total capacitive charges versus dI_F/dt (typical values)



2 Package information

- Epoxy meets UL94, V0
- Cooling method: convection (C)
- Recommended torque: 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Table 6. TO-220AC dimensions

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.40	4.60	0.173	0.181
C	1.23	1.32	0.048	0.051
D	2.40	2.72	0.094	0.107
E	0.49	0.70	0.019	0.027
F	0.61	0.88	0.024	0.034
F1	1.14	1.70	0.044	0.066
G	4.95	5.15	0.194	0.202
H2	10.00	10.40	0.393	0.409
L2	16.40 typ.		0.645 typ.	
L4	13.00	14.00	0.511	0.551
L5	2.65	2.95	0.104	0.116
L6	15.25	15.75	0.600	0.620
L7	6.20	6.60	0.244	0.259
L9	3.50	3.93	0.137	0.154
M	2.6 typ.		0.102 typ.	
Diam. I	3.75	3.85	0.147	0.151

Table 7. DPAK dimensions

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.20	2.40	0.086	0.094
A1	0.90	1.10	0.035	0.043
A2	0.03	0.23	0.001	0.009
B	0.64	0.90	0.025	0.035
B2	5.20	5.40	0.204	0.212
C	0.45	0.60	0.017	0.023
C2	0.48	0.60	0.018	0.023
D	6.00	6.20	0.236	0.244
E	6.40	6.60	0.251	0.259
G	4.40	4.60	0.173	0.181
H	9.35	10.10	0.368	0.397
L2	0.80 typ.		0.031 typ.	
L4	0.60	1.00	0.023	0.039
V2	0°	8°	0°	8°

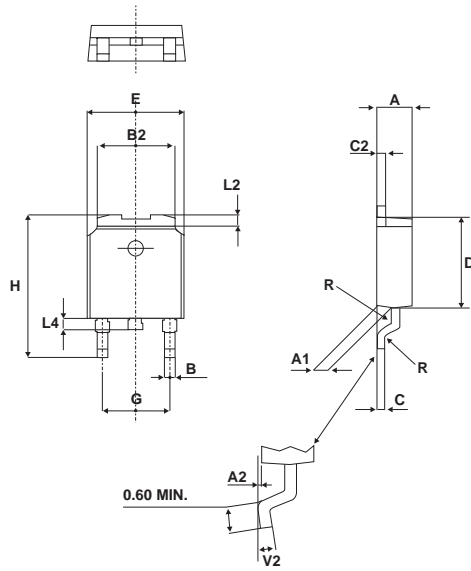
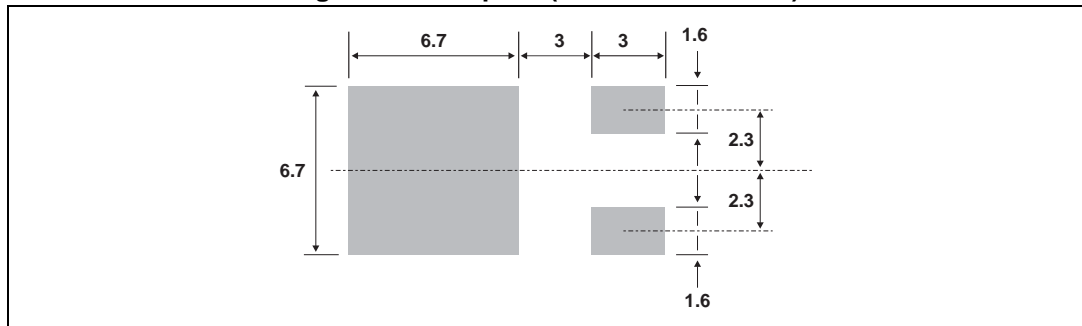


Figure 10. Footprint (dimensions in mm)



3 Ordering information

Table 8. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPSC406D	STPSC406D	TO-220AC	1.86 g	50	Tube
STPSC406B-TR	STPSC 406B	DPAK	0.3g	2500	Tape and reel

4 Revision history

Table 9. Document revision history

Date	Revision	Changes
24-Sep-2009	1	First issue.
12-Aug-2015	2	Updated Table 8: Ordering information .

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